

Surface Mount Schottky Barrier Rectifier



| Y | Y CHARACTERISTICS | | | | | |
|---|-------------------|-------|--|--|--|--|
| | • | 0.0.4 | | | | |

| PRIMARY CHARACTERISTICS | | | | |
|---|----------------|--|--|--|
| I _{F(AV)} | 2.0 A | | | |
| V _{RRM} | 40 V | | | |
| I _{FSM} | 50 A | | | |
| V_F at $I_F = 2.0$ A $(T_A = 125 ^{\circ}C)$ | 0.43 V | | | |
| T _J max. | 150 °C | | | |
| Package | DO-219AB (SMF) | | | |
| Diode variations | Single die | | | |

FEATURES

- Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current

- ROHS COMPLIANT HALOGEN FREE
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | |
|---|-----------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | SS2FL4 | UNIT | |
| Device marking code | | 2L4 | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 40 | V | |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} (1) | 2.0 | А | |
| Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J\ (init)}=25\ ^{\circ}C$ | I _{FSM} | 50 | А | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | °C | |

Note

⁽¹⁾ Free air, mounted on recommended copper pad area



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|------------------------|---------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| | I _F = 1.0 A | - T _A = 25 °C | | 0.43 | - | V |
| Instantance of few years welters | I _F = 2.0 A | | V _E ⁽¹⁾ | 0.50 | 0.58 | |
| Instantaneous forward voltage | I _F = 1.0 A | - T _A = 125 °C | T VF(') | 0.33 | - | |
| | I _F = 2.0 A | | | 0.43 | 0.51 | |
| Deverse everent | V – 10 V | T _A = 25 °C | 1 (2) | - | 220 | μA |
| Reverse current | | T _A = 125 °C | I _R ⁽²⁾ | 8 | 14 | mA |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 125 | - | pF |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 5 \text{ ms}$

| THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted) | | | | |
|---|-----------------------------|--------|------|--|
| PARAMETER | SYMBOL | SS2FL4 | UNIT | |
| Typical thormal registance | R ₀ JA (1)(2)(3) | 125 | °C/W | |
| Typical thermal resistance | R _{0JM} (2)(3) | 21 |] | |

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$ Thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| SS2FL4-M3/H | 0.015 | Н | 3000 | 7" diameter plastic tape and reel | | |
| SS2FL4-M3/I | 0.015 | I | 10 000 | 13" diameter plastic tape and reel | | |
| SS2FL4HM3/H (1) | 0.015 | Н | 3000 | 7" diameter plastic tape and reel | | |
| SS2FL4HM3/I (1) | 0.015 | I | 10 000 | 13" diameter plastic tape and reel | | |

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

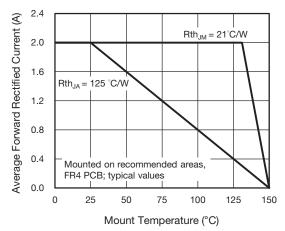


Fig. 1 - Typical Forward Current Derating Curve

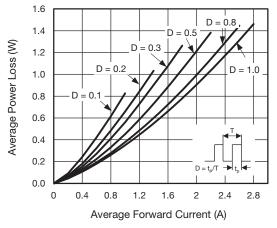


Fig. 2 - Forward Power Loss Characteristics

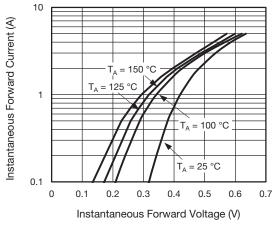


Fig. 3 - Typical Instantaneous Forward Characteristics

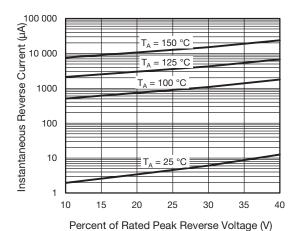


Fig. 4 - Typical Reverse Leakage Characteristics

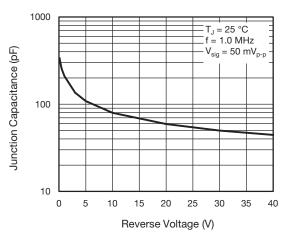


Fig. 5 - Typical Junction Capacitance

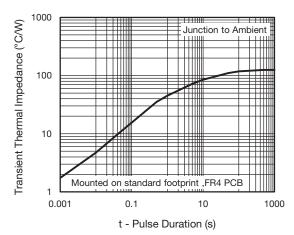
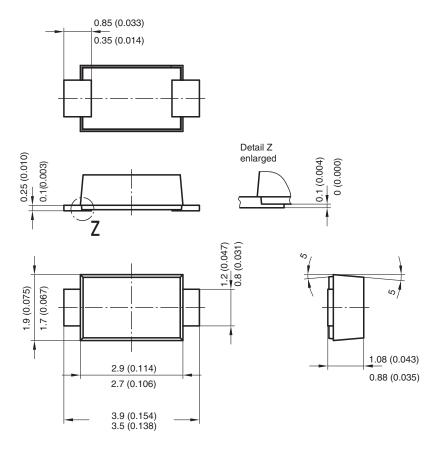


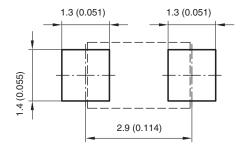
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



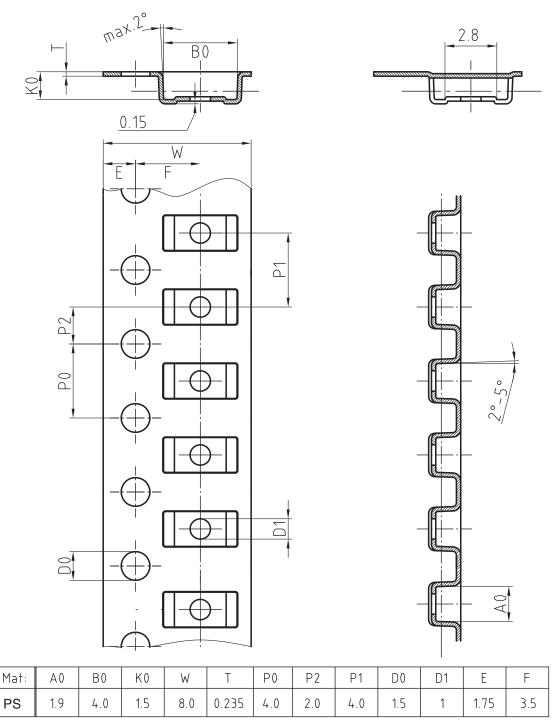
Foot print recommendation:



Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4)

17247

BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**



Document-No.: S8-V-3717.02-001 (3)

18513



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Revision: 02-Oct-12 Document Number: 91000